Product data sheet

1. General description

High power density, ultrafast switching time recovery rectifier with high-efficiency planar technology, encapsulated in D2PAK Real-2-Pin (SOT8018).

2. Features and benefits

- Reverse voltage V_R ≤ 650 V
- Forward current I_F ≤ 15 A
- Typical switching time t_{rr} of 27 ns
- · Pt doped life time control
- · Low inductance
- Planar die design
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- On Board Charger
- DC/DC converter
- AC/DC converter
- Battery heating / cooling
- Inverter
- · Freewheeling applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _c ≤ 119 °C		-	-	15	Α
V _{RRM}	repetitive peak reverse voltage	T _j = 25 °C		-	-	650	V
V _R	reverse voltage			-	-	650	V
V _F	forward voltage	I _F = 15 A; pulsed; T _j = 25 °C	[1]	-	1.36	1.68	V
		I _F = 15 A; pulsed; T _j = 125 °C	[1]	-	1.24	1.5	V
		I _F = 15 A; pulsed; T _j = 175 °C	[1]	-	1.17	-	V
I _R	reverse current	V _R = 650 V; pulsed; T _j = 25 °C	[1]	-	-	5	μΑ
		V _R = 650 V; pulsed; T _j = 125 °C	[1]	-	1.4	50	μΑ
		V _R = 650 V; pulsed; T _j = 175 °C	[1]	-	31	-	μΑ

[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	Α	anode		
mb	К	mounting base; connected to cathode, also referred to as the case	D2PAK R2P (SOT8018)	K K; mb

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PNU650150AEJ-Q	D2PAK R2P	Plastic, single-ended surface-mounted package (D2PAK R2P); Real-2-Pin configuration; 5.08 mm pitch; 8.8 mm x 10.35 mm x 4.46 mm body	SOT8018

7. Marking

Table 4. Marking codes

Type number	Marking code
PNU650150AEJ-Q	U65015AQ

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 601134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage	T _j = 25 °C		-	650	V
V _R	reverse voltage			-	650	V
V _{RMS}	RMS voltage			-	460	V
I _F	forward current	δ = 1; T _c ≤ 105 °C		-	21	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _c ≤ 119 °C		-	15	А
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; single half sine wave (applied at rated load condition); $T_{j(init)}$ = 25 °C		-	120	А
		t _p = 10 ms; square wave; T _{j(init)} = 25 °C		-	99	Α
P _{tot}	total power dissipation	T _c ≤ 25 °C	[1]	-	2.4	W
			[2]	-	4	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^{1]} Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

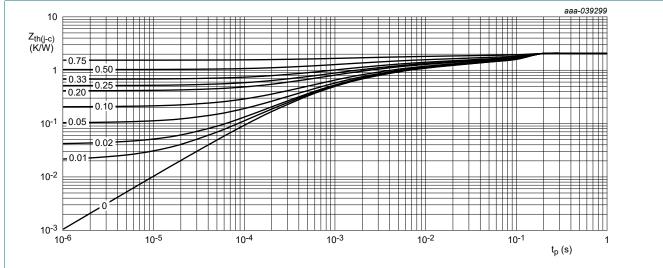
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 6 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1]	-	-	62	K/W
	junction to ambient		[2]	-	-	37	K/W
R _{th(j-c)}	thermal resistance from junction to case		[3]	-	-	2.3	K/W

- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 6 cm².
- Soldering point of cathode tab.



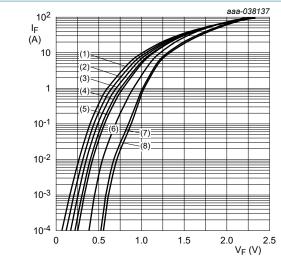
Transient thermal impedance from junction to case as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Parameter	Conditions		Min	Тур	Max	Unit
reverse breakdown voltage	I_R = 100 μA; pulsed; T_j = 25 °C	[1]	650	-	-	V
forward voltage	I _F = 15 A; pulsed; T _j = 25 °C	[1]	-	1.36	1.68	V
	I _F = 15 A; pulsed; T _j = 125 °C	[1]	-	1.24	1.5	V
	I _F = 15 A; pulsed; T _j = 175 °C	[1]	-	1.17	-	V
reverse current	V _R = 650 V; pulsed; T _j = 25 °C	[1]	-	-	5	μΑ
	V _R = 650 V; pulsed; T _j = 125 °C	[1]	-	1.4	50	μΑ
	V _R = 650 V; pulsed; T _j = 175 °C	[1]	-	31	-	μΑ
diode capacitance	V _R = 400 V; f = 1 MHz; T _j = 25 °C		-	7	-	pF
reverse recovery time; step recovery	$I_F = 0.5 \text{ A}$; $I_R = 1 \text{ A}$; $I_{R(meas)} = 0.25 \text{ A}$; $I_{T_j} = 25 \text{ °C}$		-	27	60	ns
reverse recovery time ; ramp recovery	I_F = 15 A; dI_F/dt = -200 A/µs; V_R = 400 V; T_j = 25 °C		-	119	-	ns
	I_F = 15 A; dI_F/dt = -1000 A/µs; V_R = 400 V; T_j = 25 °C		-	65	-	ns
	$I_F = 15 \text{ A}; \text{ d}I_F/\text{d}t = -200 \text{ A}/\mu\text{s};$ $V_R = 400 \text{ V}; T_j = 125 ^{\circ}\text{C}$		-	177	-	ns
	I _F = 15 A; dI _F /dt = -1000 A/µs; V _R = 400 V; T _j = 125 °C		-	90	-	ns
peak reverse recovery current	I_F = 15 A; dI_F/dt = -200 A/µs; V_R = 400 V; T_j = 25 °C		-	6	-	А
	I _F = 15 A; dI _F /dt = -1000 A/µs; V _R = 400 V; T _j = 25 °C		-	18	-	A
	I _F = 15 A; dI _F /dt = -200 A/µs; V _R = 400 V; T _j = 125 °C		-	10	-	Α
	I _F = 15 A; dI _F /dt = -1000 A/µs; V _R = 400 V; T _i = 125 °C		-	24	-	А
reverse recovery charge	I _F = 15 A; dI _F /dt = -200 A/µs; V _R = 400 V; T _j = 25 °C		-	389	-	nC
	I _F = 15 A; dI _F /dt = -1000 A/µs; V _R = 400 V; T _j = 25 °C		-	854	-	nC
	I _F = 15 A; dI _F /dt = -200 A/µs; V _R = 400 V; T _j = 125 °C		-	971	-	nC
	I _F = 15 A; dI _F /dt = -1000 A/μs; V _R = 400 V; T _i = 125 °C		-	1835	-	nC
	reverse breakdown voltage forward voltage reverse current diode capacitance reverse recovery time; step recovery reverse recovery reverse recovery remp recovery peak reverse recovery current	reverse breakdown voltage	reverse breakdown voltage	$ \begin{array}{c} \text{reverse breakdown } \\ \text{voltage} \\ \\ \text{forward voltage} \\ \\ \text{forward voltage} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	$ \begin{array}{c} \text{reverse breakdown voltage} \\ \text{forward voltage} \\ \text{forward voltage} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	$ \begin{array}{c} \text{reverse breakdown voltage} \\ \text{forward voltage} \\ \\ \text{I}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 25 ^{\circ}\text{C} \\ \\ \text{I}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{I}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{I}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{I}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 175 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 175 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 175 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 15 \text{ A; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 1.4 & 50 \\ \\ V_{\text{R}} = 650 \text{V; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 1.4 & 50 \\ \\ V_{\text{R}} = 650 \text{V; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 1.4 & 50 \\ \\ V_{\text{R}} = 650 \text{V; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 1.4 & 50 \\ \\ V_{\text{R}} = 650 \text{V; pulsed; } T_{j} = 125 ^{\circ}\text{C} \\ \\ \text{II}_{\text{F}} = 1.4 & 1.4$

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) $T_j = 175 \, ^{\circ}C$

(2) $T_j^J = 150 °C$ (3) $T_j = 125 °C$

 $(4) T_i = 100 °C$

(5) $T_i = 85 °C$

 $(6) T_i = 25 ^{\circ}C$

 $(7) T_i = -40 °C$

(8) $T_j = -55 \, ^{\circ}\text{C}$

Fig. 2. Forward current as a function of forward voltage; typical values

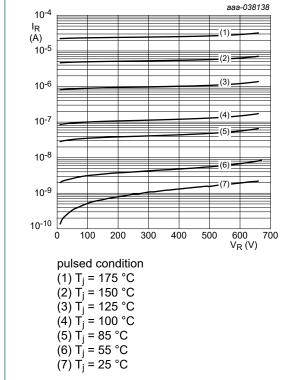


Fig. 3. Reverse current as a function of reverse voltage; typical values

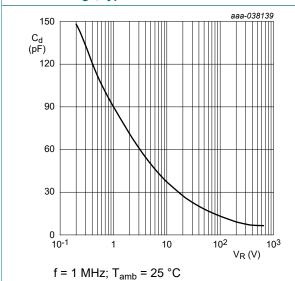
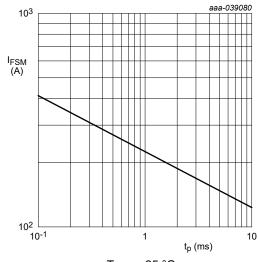
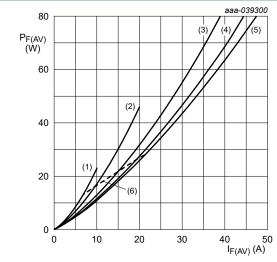


Fig. 4. Diode capacitance as a function of reverse voltage; typical values



square wave; T_{amb} = 25 °C

Fig. 5. Non-repetitive peak forward current as a function of pulse duration; typical values



 $T_j = 125$ °C

 $(1) \delta = 0.1$

(2) $\delta = 0.2$

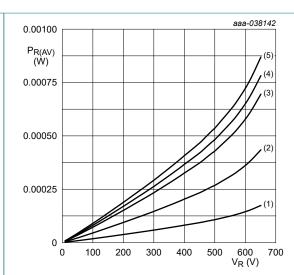
 $(3) \delta = 0.5$

 $(4) \delta = 0.8$

(5) $\delta = 1$ (DC)

(6) RMS limit

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 125$ °C

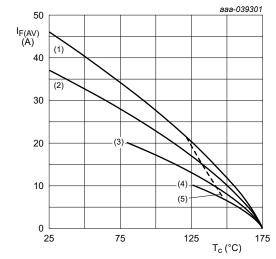
 $(1) \delta = 0.2$

 $(2) \delta = 0.5$

 $(3) \delta = 0.8$

 $(4) \delta = 0.9$ (5) $\delta = 1$ (DC)

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



 $T_i = 175 \,{}^{\circ}\text{C}$

 $(1) \delta = 1$; DC

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

(5) RMS limit

Fig. 8. Average forward current as a function of case temperature; typical values

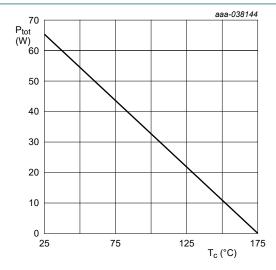
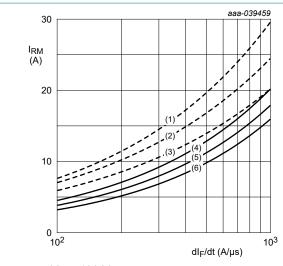


Fig. 9. Power dissipation as a function of case temperature; maximum values



(1)
$$I_F = 30 \text{ A}$$
; $T_j = 125 \,^{\circ}\text{C}$

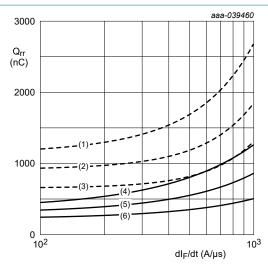
(2)
$$I_F = 15 \text{ A}$$
; $T_j = 125 ^{\circ}\text{C}$
(3) $I_F = 7.5 \text{ A}$; $T_j = 125 ^{\circ}\text{C}$

(3)
$$I_E = 7.5 \text{ A}$$
: $T_i = 125 ^{\circ}\text{C}$

(4)
$$I_F = 30 \text{ A}$$
; $T_i = 25 ^{\circ}\text{C}$

(5)
$$I_F = 15 \text{ A}; T_j = 25 ^{\circ}\text{C}$$

(6)
$$I_F = 7.5 \text{ A}; T_j = 25 ^{\circ}\text{C}$$



$$V_{R} = 400 \text{ V}$$

(1)
$$I_F = 30 \text{ A}$$
; $T_i = 125 \text{ °C}$

(2)
$$I_F = 15 \text{ A}$$
; $T_j = 125 ^{\circ}\text{C}$
(3) $I_F = 7.5 \text{ A}$; $T_j = 125 ^{\circ}\text{C}$

(3)
$$I_F = 7.5 \text{ A}$$
; $T_i = 125 ^{\circ}\text{C}$

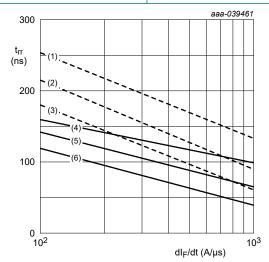
(4)
$$I_F = 30 \text{ A}; T_j = 25 ^{\circ}\text{C}$$

(5)
$$I_F = 15 \text{ A}$$
; $T_j = 25 ^{\circ}\text{C}$

(6)
$$I_F = 7.5 \text{ A}; T_j = 25 ^{\circ}\text{C}$$

Fig. 10. Peak reverse recovery current as a function of ramp rate; typical values

Fig. 11. Reverse recovery charge as a function of ramp rate; typical values



(1)
$$I_F = 30 \text{ A}$$
; $T_i = 125 \text{ °C}$

(2)
$$I_F = 15 \text{ A}$$
; $T_i = 125 \text{ °C}$

(3)
$$I_F = 7.5 \text{ A}$$
; $T_j = 125 \text{ °C}$

(4)
$$I_F = 30 A$$
; $T_i = 25 °C$

(5)
$$I_F = 15 \text{ A}$$
; $T_j = 25 ^{\circ}\text{C}$
(6) $I_F = 7.5 \text{ A}$; $T_i = 25 ^{\circ}\text{C}$

Fig. 12. Reverse recovery time as a function of ramp rate; typical values

11. Test information

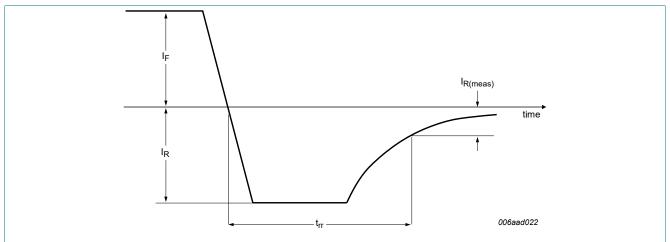


Fig. 13. Reverse recovery definition; step recovery

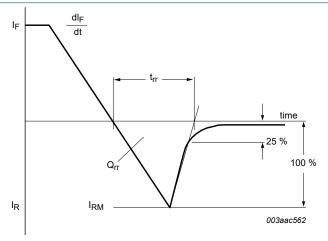


Fig. 14. Reverse recovery definition; ramp recovery

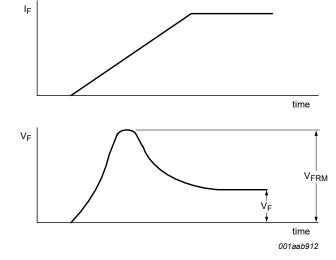
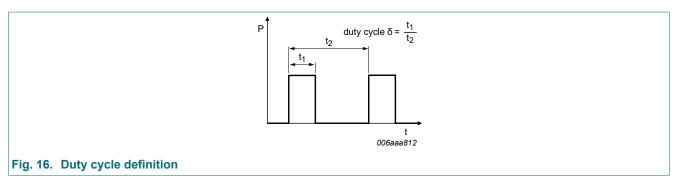


Fig. 15. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)}=I_M\times\delta$ with I_M defined as peak current

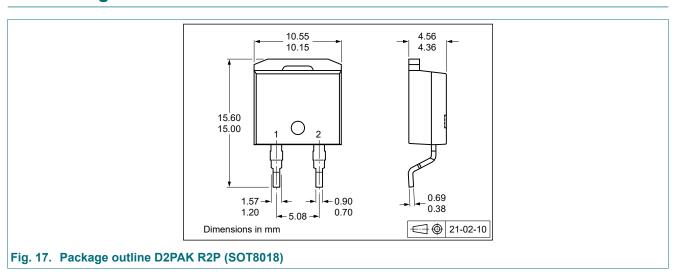
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

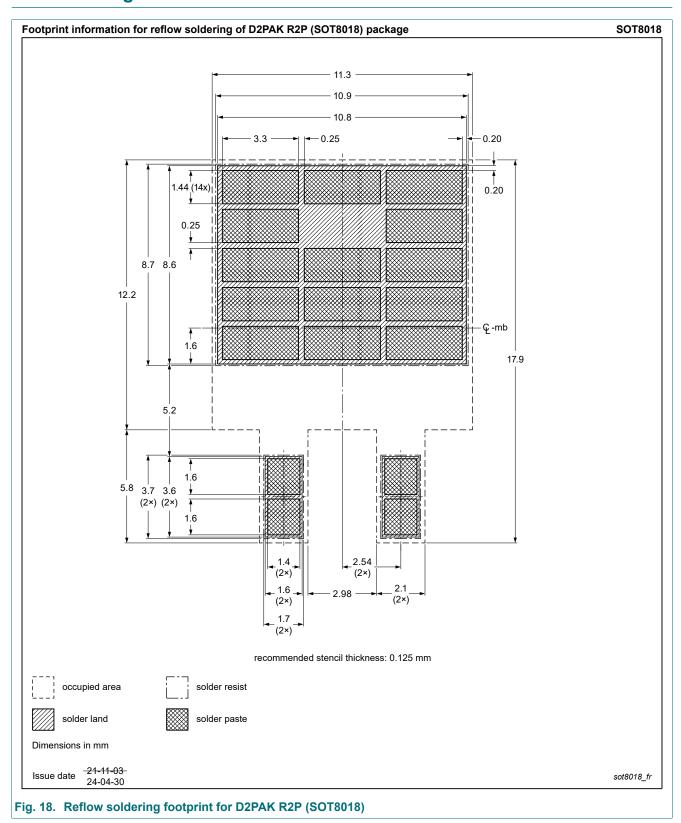
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PNU650150AEJ-Q v.1	20240503	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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	Features and benefits

For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 3 May 2024

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